



SURFACE MOUNT SCHOTTKY DIODES

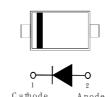
VOLTAGE 30 Volts CURRENT 200 mA

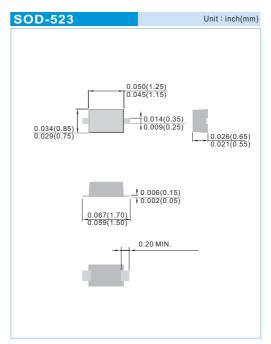
FEATURES

- · Extremely Hish Switching Speed
- Surface mount package ideally suited for autmatic insertion
- Lead free in comply with EU RoHS 2002/95/EC directives.
- Green molding compound as per IEC61249 Std. . (Halogen Free)

MECHANICAL DATA

- · Case: SOD-523, Plastic
- Terminals: Solderable per MIL-STD-750, Method 2026
- Appox Weight: 0.0014 grams
- Marking: 20





ABSOLUTE RATINGS

PARAMETER	Symbol	Value	Units
Peak Reverse Voltage	V _R	30	V
Maximum Forward Current	I ₀	0.2	А
Peak Forward Surge Current 1000ms Single half sine-wave superimposed on rate load (JEDEC method)	I _{FSM}	1	А
Operating Junction and Storage Temperature Range	$T_{J,}T_{STG}$	-55 to + 125	°C

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise noted)

PARAMETER	Symbol	Test Condition	MIN.	TYP.	MAX.	Units
Reverse Leakage Current	I _R	V _R =10V	-	-	1.0	μΑ
Forward Voltage	V _{F1}	I _F =20mA	-	-	0.40	V
Forward Voltage	V _{F2}	I _F =200mA	-	-	0.60	V
Total Capacitance	CJ	V _R =0V,F=1MHz	-	30	-	pF





RATING AND CHARACTERISTIC CURVES

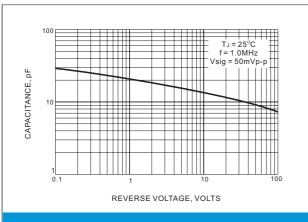


FIG.1 TYPICAL JUNCTION CAPACITANCE

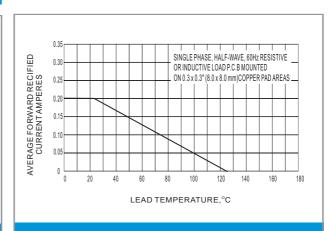


FIG.2 MAXIMUM AVERAGE FORWARD CURRENT DERATING

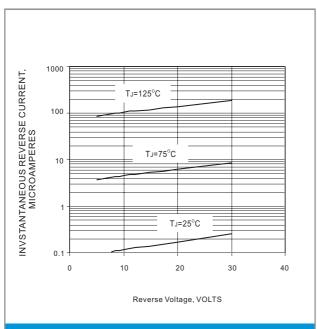


Fig.3 Typical Reverse Characteristics

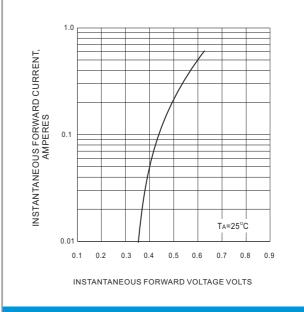
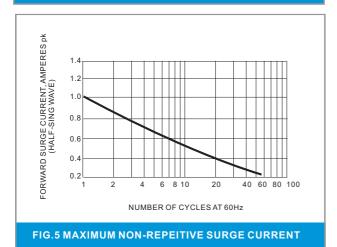


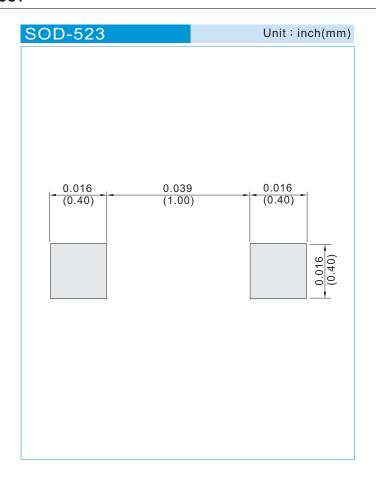
FIG.4 TYPICAL FORWARD CHARACTERISTICS







MOUNTING PAD LAYOUT



ORDER INFORMATION

Packing information

T/R - 12K per 13" plastic Reel

T/R - 5K per 7" plastic Reel

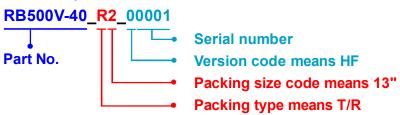




Part No_packing code_Version

RB520S30_R1_00001 RB520S30_R2_00001

For example:



Packing Code XX			Version Code XXXXX			
Packing type	1 st Code	Packing size code	2 nd Code	HF or RoHS	1 st Code	2 nd ~5 th Code
Tape and Ammunition Box (T/B)	Α	N/A	0	HF	0	serial number
Tape and Reel (T/R)	R	7"	1	RoHS	1	serial number
Bulk Packing (B/P)	В	13"	2			
Tube Packing (T/P)	Т	26mm	X			
Tape and Reel (Right Oriented) (TRR)	S	52mm	Y			
Tape and Reel (Left Oriented) (TRL)	L	PANASERT T/B CATHODE UP (PBCU)	U			
FORMING	F	PANASERT T/B CATHODE DOWN (PBCD)	D			





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